



PCB Layout Diagram  
Top View

**NOTE:**

**1. MATERIAL:**

- a. HOUSING: PPA
- b. CONTACT: PHOSPHOR BRONZE  
(SURFACE PLATING: Au\*U")

SEE ORDERING INFORMATION

**2. ELECTRIC:**

- a. CONTACT RESISTANCE: 30 MILLIOHMS MAX
- b. INSULATION RESISTANCE: 1000 MEGA OHMS MI
- c. DIELECTRIC VOLTAGE: 500V AC ONE SEC LEVE
- d. OPERATING TEMPERATURE: -25 ° C ~ +85 ° C

3	TERMINAL (-)	1	PHOSPHOR BRONZE, T=0.20MM	Gold Plating and Ni Under-Plating
2	TERMINAL (+)	1	PHOSPHOR BRONZE, T=0.20MM	Gold Plating and Ni Under-Plating
1	HOUSING	1	PPA	BROWN
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	A		NEW			

<b>APPROVALS</b>		<b>DATE</b>	<b>TITILE:</b>			
<b>DRAWN</b>	ZHIWEI.CHEN	2015.07.07	电池座 SMT			
<b>CHECKED</b>			PART NO. GP07-CR2032-13			
<b>APPROVALS</b>			SCALE: 1:1			
<b>TOLERANCES ARE</b>			<b>ANGLE</b>		<b>UNIT: mm</b>	<b>PROJ:</b>
30~以上	±0.30		±2°		mm	PROJ:
10~30	±0.20					
5~10	±0.15					
~ 5	±0.10					



**深圳市联丰电子有限公司**  
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